

Hyperfast Rectifier, 30 A FRED Pt® G5



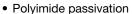
| PRIMARY CHARACTERISTICS | | | | | |
|--|-------------|--|--|--|--|
| I _{F(AV)} | 30 A | | | | |
| V_{R} | 1200 V | | | | |
| V _F at I _F at 125 °C | 2.1 V | | | | |
| t _{rr} | 26 ns | | | | |
| T _J max. | 175 °C | | | | |
| Package | TO-220AC 2L | | | | |
| Circuit configuration | Single | | | | |

FEATURES

- · Hyperfast and optimized Q_{rr}
- Best in class forward voltage drop and switching losses trade off



• 175 °C maximum operating junction temperature



 Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for high frequency converters, both soft switched / resonant. Specifically designed to improve efficiency of PFC and output rectification stages of EV / HEV battery charging stations, booster stage of solar inverters and UPS applications, these devices are perfectly matched to operate with MOSFETs or high speed IGBTs.

| ABSOLUTE MAXIMUM RATINGS | | | | | | | |
|--|-----------------------------------|--|-------------|-------|--|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | | |
| Repetitive peak reverse voltage | V_{RRM} | | 1200 | V | | | |
| Average rectified forward current | I _{F(AV)} | T _C = 90 °C, D = 0.50 | 30 | | | | |
| Non-repetitive peak surge current | I _{FSM} | $T_C = 45$ °C, $t_p = 10$ ms, sine wave | 210 | Α | | | |
| Repetitive peak forward current | I _{FRM} | T _C = 90 °C, D = 0.50, f = 20 kHz | 60 | | | | |
| Operating junction and storage temperature | T _J , T _{Stg} | | -55 to +175 | °C | | | |

| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | | |
|--|-------------------------------------|--|------|------|------|-------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Breakdown voltage, blocking voltage | V _{BR} , V _R | I _R = 100 μA | 1200 | - | - | | |
| Forward voltage | V _F | I _F = 30 A | - | 2.6 | 3.15 | V | |
| | | I _F = 30 A, T _J = 125 °C | - | 2.1 | - | , | |
| Deviates legisare guitant | I _R | $V_R = V_R$ rated | - | - | 50 | μА | |
| Reverse leakage current | | T _J = 125 °C, V _R = V _R rated | - | - | 500 | | |
| Junction capacitance | C _T | V _R = 200 V | - | 17 | - | pF | |
| Series inductance | L _S | Measured to lead 5 mm from package body | - | 8 | - | nH | |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | | |
|---|------------------|---|--|------|------|-------|------|--|
| PARAMETER | SYMBOL | TEST CO | MIN. | TYP. | MAX. | UNITS | | |
| | | I _F = 1.0 A, dI _F /dt = | $I_F = 1.0 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$ | | 26 | - | | |
| Reverse recovery time | t _{rr} | T _J = 25 °C | | - | 100 | - | ns | |
| | | T _J = 125 °C | | - | 150 | - | 1 | |
| Peak recovery current | 1 | T _J = 25 °C | $I_F = 20 \text{ A}$ $dI_F/dt = 600 \text{ A/}\mu\text{s}$ $V_R = 400 \text{ V}$ | - | 12 | - | Α | |
| | I _{RRM} | T _J = 125 °C | | - | 22 | - | | |
| Deviana vacavam debaras | Q _{rr} | T _J = 25 °C | | - | 530 | - | nC | |
| Reverse recovery charge | | T _J = 125 °C | | - | 1550 | - | | |
| Deviana nagavan tima | | T _J = 25 °C | I _F = 30 A dI _F /dt = 1000 A/μs V _R = 800 V | - | 80 | - | ns A | |
| Reverse recovery time | t _{rr} | T _J = 125 °C | | - | 120 | - | | |
| Dools recovery as weath | | T _J = 25 °C | | - | 22 | - | | |
| Peak recovery current | I _{RRM} | T _J = 125 °C | | - | 37 | - | | |
| Reverse recovery charge | Q _{rr} | T _J = 25 °C | | - | 900 | - | nC | |
| | | T _J = 125 °C | | - | 2300 | - | | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | | |
|--|-----------------------------------|-------------------------|--------------|------|------------|------------------------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Thermal resistance, junction-to-case | R _{thJC} | | - | - | 1.2 | °C/W | |
| Weight | | | - | 2.0 | - | g | |
| | | | - | 0.07 | - | oz. | |
| Mounting torque | | | 6.0 (5.0) | - | 12 (10) | kgf · cm (lbf · in) | |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -55 | - | 175 | °C | |
| Marking device | | Case style: 2L TO-220AC | E5TX3012 | | | | |

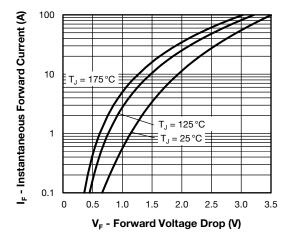


Fig. 1 - Typical Forward Voltage Drop Characteristics

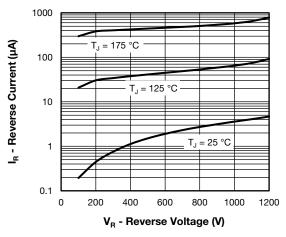


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



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Vishay Semiconductors

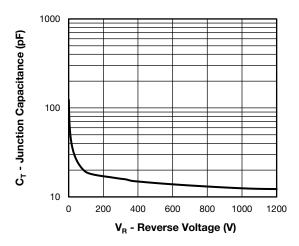


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

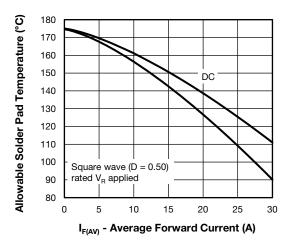


Fig. 4 - Maximum Allowable Case Temperature vs.
Average Forward Current

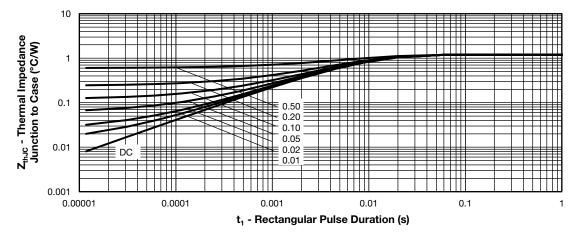


Fig. 5 - Thermal Impedance Z_{thJC} Characteristics

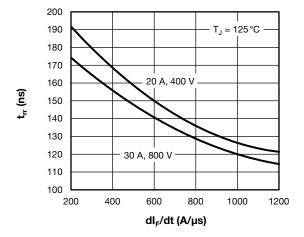


Fig. 6 - Typical Reverse Recovery Time vs. dI_F/dt

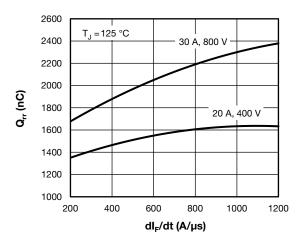


Fig. 7 - Typical Stored Charge vs. dl_F/dt

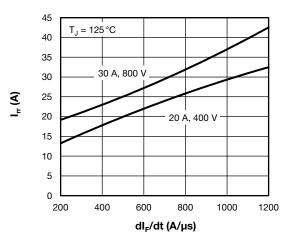


Fig. 8 - Typical Recovery Current vs. dl_F/dt

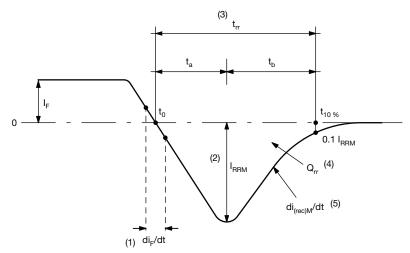


Fig. 9 - Reverse Recovery Waveform and Definitions

Notes

- $^{(1)}$ di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from t_0 , crossing point of negative going I_F , to point $t_{10\%}$, 0.1 I_{RRM}
- $^{(4)}$ Q_{rr} area under curve defined by t_0 and $t_{10\,\%}$

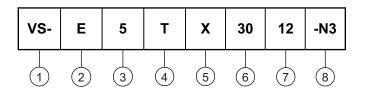
$$Q_{rr} = \int_{t_0}^{t_{10}\%} I(t)dt$$

 $^{(5)}$ di_(rec)M/dt - peak rate of change of current during t_b portion of t_{rr}



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - E = single diode

3 - 5 = Fred generation 5

4 - Package:

T = TO-220AC 2L

5 - X = hyperfast recovery

6 - Current rating (30 = 30 A)

7 - Voltage rating (12 = 1200 V)

8 - Environmental digit:

-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

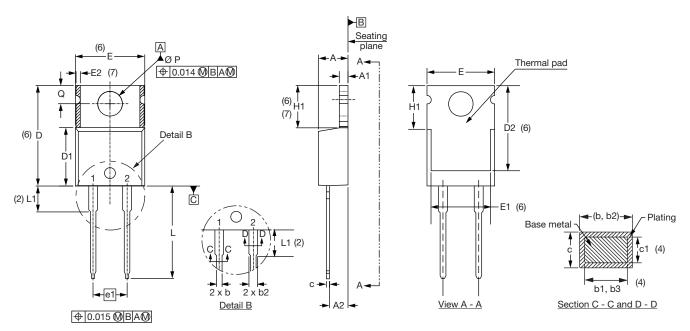
| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|-------------------|------------------------|-------------------------|--|--|--|
| PREFERRED P/N | QUANTITY PER TUBE | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION | | | |
| VS-E5TX3012-N3 | 50 | 1000 | Antistatic plastic tube | | | |

| LINKS TO RELATED DOCUMENTS | | | | | |
|----------------------------|--------------------------|--|--|--|--|
| Dimensions | www.vishay.com/doc?96069 | | | | |
| Part marking information | www.vishay.com/doc?95391 | | | | |
| SPICE model | www.vishay.com/doc?96701 | | | | |



2L TO-220AC

DIMENSIONS in millimeters and inches



| SYMBOL | MILLIM | IETERS | INC | INCHES | |
|---------|--------|--------|-------|--------|-------|
| STIMBOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 4.25 | 4.65 | 0.167 | 0.183 | |
| A1 | 1.14 | 1.40 | 0.045 | 0.055 | |
| A2 | 2.56 | 2.92 | 0.101 | 0.115 | |
| b | 0.69 | 1.01 | 0.027 | 0.040 | |
| b1 | 0.38 | 0.97 | 0.015 | 0.038 | 4 |
| b2 | 1.20 | 1.73 | 0.047 | 0.068 | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| c1 | 0.36 | 0.56 | 0.014 | 0.022 | 4 |
| D | 14.85 | 15.25 | 0.585 | 0.600 | 3 |
| D1 | 8.38 | 9.02 | 0.330 | 0.355 | |
| D2 | 11.68 | 12.88 | 0.460 | 0.507 | 6 |
| Е | 10.11 | 10.51 | 0.398 | 0.414 | 3, 6 |

| SYMBOL | MILLIN | IETERS | INC | HES | NOTES |
|----------|--------|--------|-------|-------|-------|
| STIVIBUL | MIN. | MAX. | MIN. | MAX. | NOTES |
| E1 | 6.86 | 8.89 | 0.270 | 0.350 | 6 |
| E2 | - | 0.76 | - | 0.030 | 7 |
| e1 | 4.88 | 5.28 | 0.192 | 0.208 | |
| H1 | 5.84 | 6.86 | 0.230 | 0.270 | 6, 7 |
| L | 13.52 | 14.02 | 0.532 | 0.552 | |
| L1 | 3.32 | 3.82 | 0.131 | 0.150 | 2 |
| ØΡ | 3.54 | 3.73 | 0.139 | 0.147 | |
| Q | 2.60 | 3.00 | 0.102 | 0.118 | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC® TO-220, except D2, where JEDEC® minimum is 0.480"



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